# NCE N-Channel Enhancement Mode Power MOSFET

#### **DESCRIPTION**

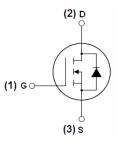
The NCE0157D uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

#### **GENERAL FEATURES**

- $V_{DS} = 100V, I_D = 57A$  $R_{DS(ON)} < 23m\Omega @ V_{GS} = 10V$
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

#### **Application**

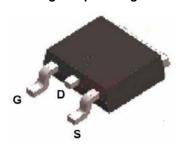
- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



Schematic diagram



Marking and pin Assignment



TO-263-2L top view

# **Package Marking And Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0157D	NCE0157D	TO-263-2L	-	-	-

#### Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
	I <sub>D</sub>	57	А
Drain Current-Continuous@ Current-Pulsed (Note 1)	I <sub>D</sub> (100℃)	54	Α
	V <sub>DS</sub> 10 V <sub>GS</sub> ±2  I <sub>D</sub> 5  I <sub>D</sub> (100°C) 5  I <sub>DM</sub> 22  P <sub>D</sub> 20  1.0  E <sub>AS</sub> 58	210	Α
Maximum Power Dissipation	P <sub>D</sub>	200	W
Derating factor		1.61	W/°C
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	580	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	$^{\circ}$ C

# **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	0.62	°C/W	
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#### Electrical Characteristics (TA=25°C unless otherwise noted)

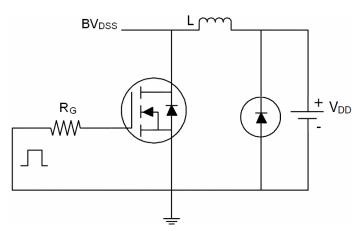
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V			1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±100	nA
On Characteristics (Note 3)	<u>.</u>					
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	2		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =28A		13.3	23	mΩ
Forward Transconductance	<b>g</b> Fs	V <sub>DS</sub> =25V,I <sub>D</sub> =28A	32			S
Dynamic Characteristics (Note4)	<u>.</u>					
Input Capacitance	C <sub>lss</sub>	\/ O5\/\/ O\/		2700		PF
Output Capacitance	Coss	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,		350		PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		150		PF
Switching Characteristics (Note 4)	<u>.</u>					
Turn-on Delay Time	t <sub>d(on)</sub>			12		nS
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> =50V,I <sub>D</sub> =28A		55		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =2.5 $\Omega$		45		nS
Turn-Off Fall Time	t <sub>f</sub>			47		nS
Total Gate Charge	Qg	\/ -00\/ L -20A		95		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =80V, $I_{D}$ =28A, $V_{GS}$ =10V		18		nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V		25		nC
Drain-Source Diode Characteristics	<u>.</u>					
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =28A		0.85	1.2	V
Diode Forward Current (Note 2)	Is				57	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 28A 140		140	220	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs(Note3) 650 1		1000	nC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				

# Notes:

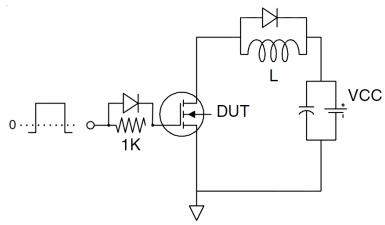
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25  $^{\circ}\text{C}$  ,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$

# **Test circuit**

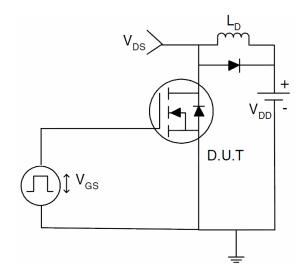
# 1) E<sub>AS</sub> test Circuits



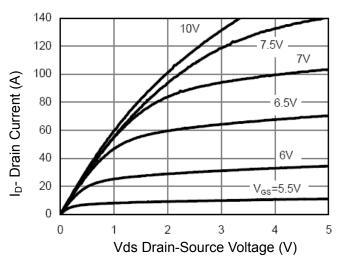
# 2) Gate charge test Circuit:



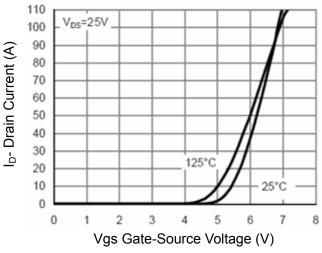
# 3) Switch Time Test Circuit:



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

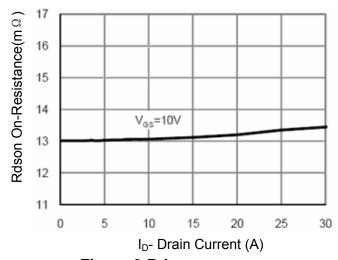


Figure 3 Rdson- Drain Current

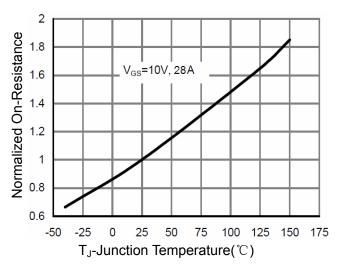


Figure 4 Rdson-JunctionTemperature

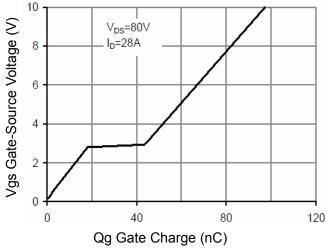


Figure 5 Gate Charge

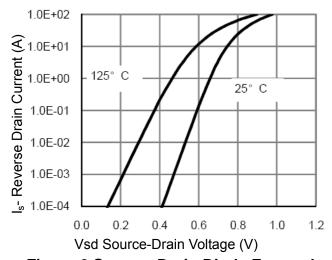


Figure 6 Source- Drain Diode Forward

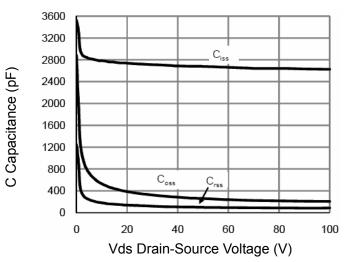


Figure 7 Capacitance vs Vds

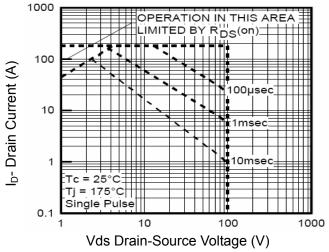


Figure 8 Safe Operation Area

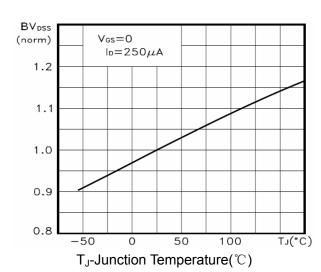


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

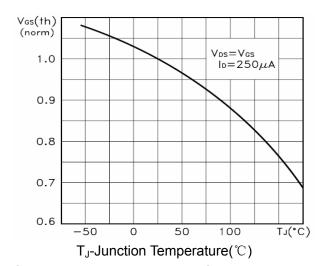


Figure 10 V<sub>GS(th)</sub> vs Junction Temperatur

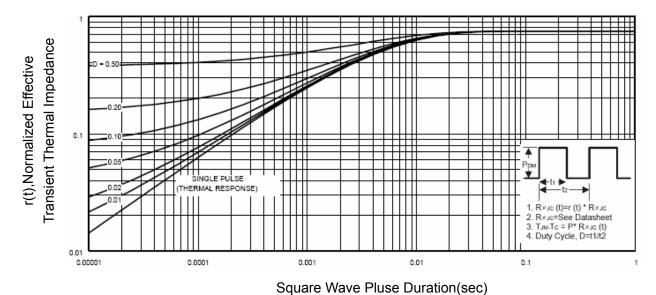
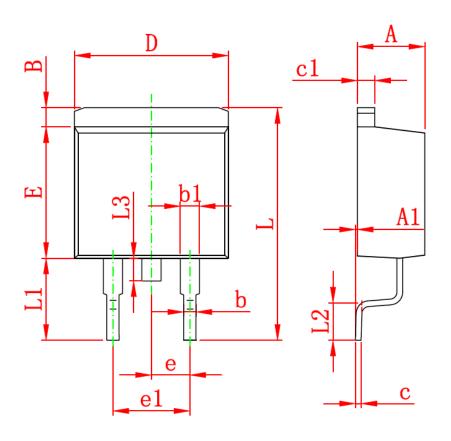
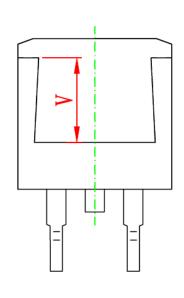


Figure 11 Normalized Maximum Transient Thermal Impedance

# **TO-263-2L PACKAGE INFORMATION**





Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	4.470	4.670	0.176	0.184	
A1	0.000	0.150	0.000	0.006	
В	1.170	1.370	0.046	0.054	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
с	0.310	0.530	0.012	0.021	
c1	1.170	1.370	0.046	0.054	
D	10.010	10.310	0.394	0.406	
E	8.500	8.900	0.335	0.350	
e	2.540 (TYP.)		0.100 (TYP.)		
e1	4.980	5.180	0.196	0.204	
L	15.050	15.450	0.593	0.608	
L1	5.080	5.480	0.200	0.216	
L2	2.340	2.740	0.092	0.108	
L3	1.300	1.700	0.051	0.067	
V	5.600	REF.	0.220 REF.		

**NCE0157D** 

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